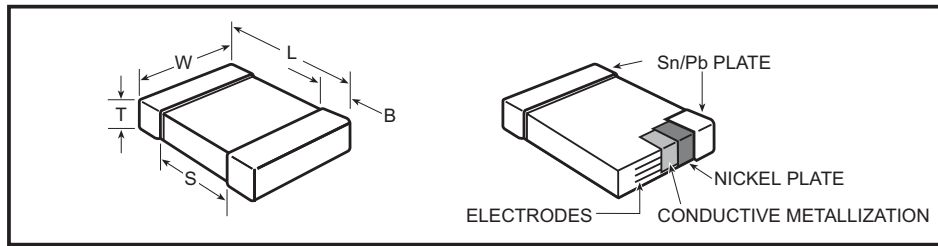


### FEATURES

KEMET's line of Tin/Lead termination commercial MLCC surface mount capacitors are designed to meet the needs of the commercial, high reliability, and military customer applications where Tin/Lead plating is required. KEMET's Tin/Lead electroplating process is designed to meet a 5% minimum lead content in the termination of the component. As the bulk of the electronics industry marches to RoHS compliance it is important that KEMET provide the Tin/Lead terminated products for our valued high reliability and military customers.

KEMET Tin/Lead MLCC surface mount capacitors are available in standard EIA case sizes from 0402 to 2225 and standard capacitance values in X7R and C0G dielectrics. Voltage ratings range from 6.3V to 200V. To order the Tin/Lead terminations indicate an "L" in the 14<sup>th</sup> digit of the part number. To request the L Series termination for other surface mount product lines (Open Mode, High Voltage, Arrays, etc.) or for additional dielectrics and higher voltage ratings, please contact the factory or local Sales representative.

### CAPACITOR OUTLINE DRAWINGS

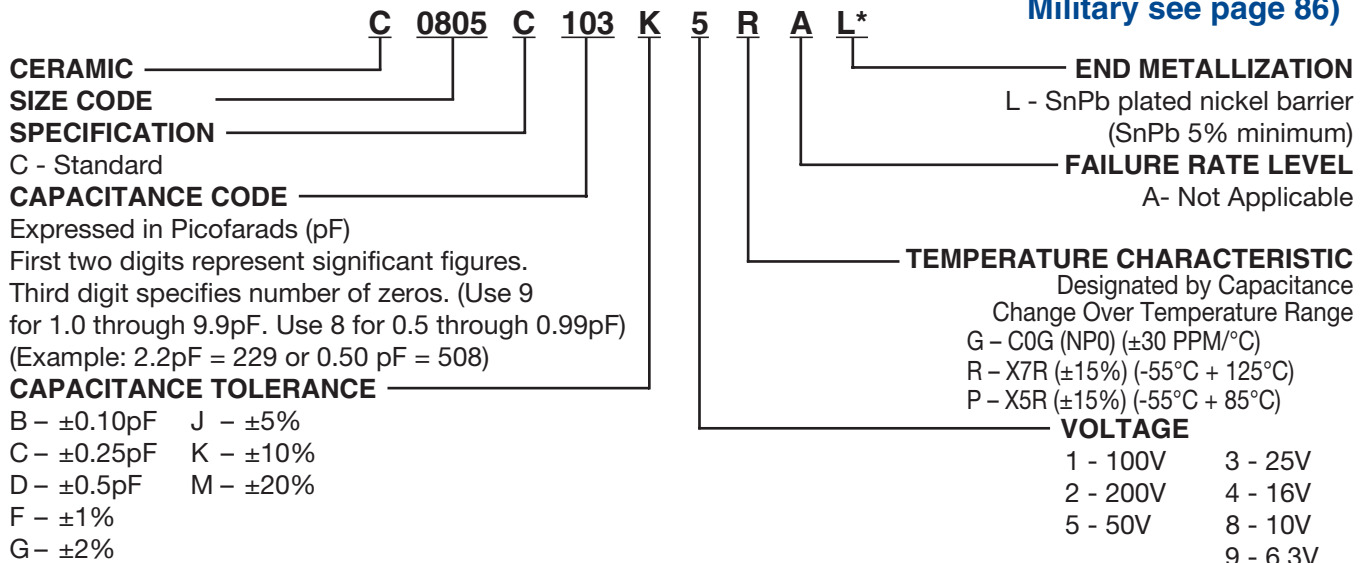


### DIMENSIONS—MILLIMETERS AND (INCHES)

EIA SIZE CODE	METRIC SIZE CODE (Ref only)	L # LENGTH	W # WIDTH	See page 77 for thickness dimensions.	B BANDWIDTH		S MIN. SEPARATION		MOUNTING TECHNIQUE
					mm	in	mm	in	
0402*	1005	1.0 (.04) ± .05 (.002)	0.5 (.02) ± .05 (.002)		0.20 (0.008)-0.40 (0.016)	0.3 (.012)			Solder Reflow
0603*	1608	1.6 (.063) ± 0.15 (.006)	0.8 (.032) ± 0.15 (.006)		0.35 (.014) ± 0.15 (.006)	0.7 (.028)			Solder Wave † or Solder Reflow
0805*	2012	2.0 (.079) ± 0.2 (.008)	1.25 (.049) ± 0.2 (.008)		0.5 (.02) ± .25 (.010)	0.75 (.030)			
1206*	3216	3.2 (.126) ± 0.2 (.008)	1.6 (.063) ± 0.2 (.008)		0.5 (.02) ± .25 (.010)	N/A			
1210*	3225	3.2 (.126) ± 0.2 (.008)	2.5 (.098) ± 0.2 (.008)		0.5 (.02) ± .25 (.010)	N/A			Solder Reflow
1812	4532	4.5 (.177) ± 0.3 (.012)	3.2 (.126) ± 0.3 (.012)		0.6 (.024) ± .35 (.014)	N/A			
1825*	4564	4.5 (.177) ± 0.3 (.012)	6.4 (.252) ± 0.4 (.016)		0.6 (.024) ± .35 (.014)	N/A			
2220	5650	5.6 (.220) ± 0.4 (.016)	5.0 (.197) ± 0.4 (.016)		0.6 (.024) ± .35 (.014)	N/A			
2225	5664	5.6 (.220) ± 0.4 (.016)	6.3 (.248) ± 0.4 (.016)	0.6 (.024) ± .35 (.014)	N/A				

\* Note: Indicates EIA Preferred Case Sizes (Tightened tolerances apply for 0402, 0603, and 0805 packaged in bulk cassette, see page 96).  
 † For extended value 1210 case size - solder reflow only.

### CAPACITOR ORDERING INFORMATION (Standard Chips - For Military see page 86)



\* Part Number Example: C0805C103K5RAL (14 digits - no spaces)

Refer to pages 72-75 for NP0/C0G, X7R and X5R dielectric capacitance ranges available.

## Thickness Code Reference Chart Packaging Quantity Based on Finished Chip Thickness Specifications

Thickness Code	Chip Size	Chip Thickness Range (mm)	Qty per Reel 7" Plastic	Qty per Reel 13" Plastic	Qty per Reel 7" Paper	Qty per Reel 13" Paper	Qty per Bulk Cassette
AA	0201	.30 ± .03	N/A	N/A	15,000	N/A	N/A
BB	0402	.50 ± .05	N/A	N/A	10,000	50,000	50,000
CB	0603	.80 ± .07	N/A	N/A	4,000	10,000	15,000
CC	0603	.80 ± .10	N/A	N/A	4,000	10,000	N/A
CD	0603	.80 ± .15	N/A	N/A	4,000	10,000	N/A
DB	0805	.60 ± .10	N/A	N/A	N/A	N/A	10,000
DC	0805	.78 ± .10	4,000	10,000	4,000	10,000	N/A
DD	0805	.90 ± .10	4,000	10,000	N/A	N/A	N/A
DE	0805	1.00 ± .10	2,500	10,000	N/A	N/A	N/A
DF	0805	1.10 ± .10	2,500	10,000	N/A	N/A	N/A
DG	0805	1.25 ± .15	2,500	10,000	N/A	N/A	N/A
DH	0805	1.25 ± .20	2,500	10,000	N/A	N/A	N/A
DJ	0805	1.25 ± .20	3,000	10,000	N/A	N/A	N/A
DK	0805	1.25 ± .15	3,000	10,000	N/A	N/A	N/A
EB	1206	.78 ± .10	4,000	10,000	4,000	10,000	N/A
EC	1206	.90 ± .10	4,000	10,000	N/A	N/A	N/A
ED	1206	1.00 ± .10	2,500	10,000	N/A	N/A	N/A
EE	1206	1.10 ± .10	2,500	10,000	N/A	N/A	N/A
EF	1206	1.20 ± .15	2,500	10,000	N/A	N/A	N/A
EG	1206	1.60 ± .15	2,000	8,000	N/A	N/A	N/A
EH	1206	1.60 ± .20	2,000	8,000	N/A	N/A	N/A
EJ	1206	1.70 ± .20	2,000	8,000	N/A	N/A	N/A
EK	1206	.80 ± .10	2,000	8,000	N/A	N/A	N/A
EL	1206	1.15 ± .15	2,000	8,000	N/A	N/A	N/A
EM	1206	1.25 ± .15	2,500	10,000	N/A	N/A	N/A
EN	1206	0.95 ± .10	4,000	10,000	N/A	N/A	N/A
FB	1210	.78 ± .10	4,000	10,000	N/A	N/A	N/A
FC	1210	.90 ± .10	4,000	10,000	N/A	N/A	N/A
FD	1210	.95 ± .10	4,000	10,000	N/A	N/A	N/A
FE	1210	1.00 ± .10	2,500	10,000	N/A	N/A	N/A
FF	1210	1.10 ± .10	2,500	10,000	N/A	N/A	N/A
FG	1210	1.25 ± .15	2,500	10,000	N/A	N/A	N/A
FH	1210	1.55 ± .15	2,000	8,000	N/A	N/A	N/A
FJ	1210	1.85 ± .20	2,000	8,000	N/A	N/A	N/A
FK	1210	2.10 ± .20	2,000	8,000	N/A	N/A	N/A
FL	1210	1.40 ± .15	2,000	8,000	N/A	N/A	N/A
FM	1210	1.70 ± .20	2,000	8,000	N/A	N/A	N/A
FN	1210	1.85 ± .20	2,000	8,000	N/A	N/A	N/A
FO	1210	1.50 ± .20	2,000	8,000	N/A	N/A	N/A
FP	1210	1.60 ± .20	2,000	8,000	N/A	N/A	N/A
FQ	1210	2.5 ± .20	1,500	8,000	N/A	N/A	N/A
FR	1210	2.25 ± .20	2,000	8,000	N/A	N/A	N/A
FS	1210	2.50 ± .20	1,000	4,000	N/A	N/A	N/A
FT	1210	1.90 ± .20	1,500	4,000	N/A	N/A	N/A
GB	1812	1.00 ± .10	1,000	4,000	N/A	N/A	N/A
GC	1812	1.10 ± .10	1,000	4,000	N/A	N/A	N/A
GD	1812	1.25 ± .15	1,000	4,000	N/A	N/A	N/A
GE	1812	1.30 ± .10	1,000	4,000	N/A	N/A	N/A
GF	1812	1.50 ± .10	1,000	4,000	N/A	N/A	N/A
GG	1812	1.55 ± .10	1,000	4,000	N/A	N/A	N/A
GH	1812	1.40 ± .15	1,000	4,000	N/A	N/A	N/A
GJ	1812	1.70 ± .15	1,000	4,000	N/A	N/A	N/A
GK	1812	1.60 ± .20	1,000	4,000	N/A	N/A	N/A
GL	1812	1.90 ± .20	1,000	4,000	N/A	N/A	N/A
GM	1812	2.00 ± .20	1,000	4,000	N/A	N/A	N/A
GN	1812	1.70 ± .20	1,000	4,000	N/A	N/A	N/A
HB	1825	1.10 ± .15	1,000	4,000	N/A	N/A	N/A
HC	1825	1.15 ± .15	1,000	4,000	N/A	N/A	N/A
HD	1825	1.30 ± .15	1,000	4,000	N/A	N/A	N/A
HE	1825	1.40 ± .15	1,000	4,000	N/A	N/A	N/A
HF	1825	1.50 ± .15	1,000	4,000	N/A	N/A	N/A
JB	2220	1.00 ± .15	1,000	4,000	N/A	N/A	N/A
JC	2220	1.10 ± .15	1,000	4,000	N/A	N/A	N/A
JD	2220	1.30 ± .15	1,000	4,000	N/A	N/A	N/A
JE	2220	1.40 ± .15	1,000	4,000	N/A	N/A	N/A
JF	2220	1.50 ± .15	1,000	4,000	N/A	N/A	N/A
KB	2225	1.00 ± .15	1,000	4,000	N/A	N/A	N/A
KC	2225	1.10 ± .15	1,000	4,000	N/A	N/A	N/A
KD	2225	1.30 ± .15	1,000	4,000	N/A	N/A	N/A
KE	2225	1.40 ± .15	1,000	4,000	N/A	N/A	N/A

This chart refers to ceramic chip thickness codes on pages 72-75.